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COMPLIANT

HALOGEN

FREE

Ultrafast Avalanche SMD Rectifier



SMA (DO-214AC)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.5 A			
V_{RRM}	200 V, 400 V, 600 V			
I _{FSM}	30 A			
I _R	1.0 μA			
V _F at I _F	1.4 V			
t _{rr}	75 ns			
E _R	20 mJ			
T_J max.	150 °C			
Package	SMA (DO-214AC)			
Diode variations	Single			

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- · Soft recovery characteristics
- Ultrafast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG20D	BYG20G	BYG20J	UNIT
Device marking code		BYG20D	BYG20G	BYG20J	
Maximum repetitive peak reverse voltage	V _{RRM}	200	400	600	V
Average forward current	I _{F(AV)}	1.5			Α
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30			А
Pulse energy in avalanche mode, non repetitive (inductive load switch off) I _{(BR)R} = 1 A, T _J = 25 °C	E _R	20			mJ
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150			°C

BYG20D, BYG20G, BYG20J

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG20D	BYG20G	BYG20J	UNIT
Maximum instantaneous	I _F = 1 A	T _{.I} = 25 °C V _F ⁽¹⁾		1.3		V	
forward voltage	I _F = 1.5 A	11 = 25 0	V _F (··)	1.4]
Maximum DC reverse current	V - V	T _J = 25 °C	1			- μΑ	
	$V_R = V_{RRM}$	T _J = 100 °C	IR	10			
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	75		ns	

Note

 $^{^{(1)}\,}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG20D BYG20G BYG20J			UNIT
Typical thermal resistance, junction to lead, T _L = const.	$R_{\theta JL}$	25			°C/W
Typical thermal resistance, junction to ambient	R ₀ JA (1)	150			
	R _{0JA} (2)	125		°C/W	
	R _{0JA} (3)		100		

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 µm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYG20D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG20D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG20DHM3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG20DHM3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

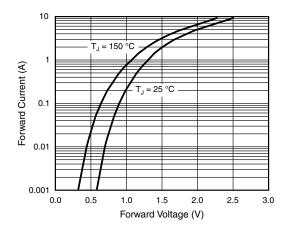


Fig. 1 - Forward Current vs. Forward Voltage

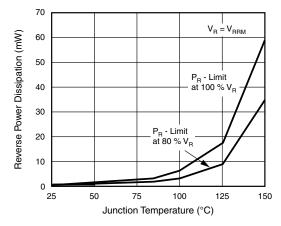


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

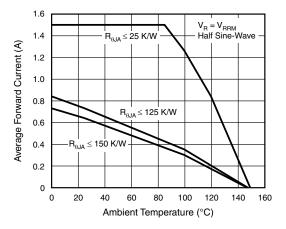


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

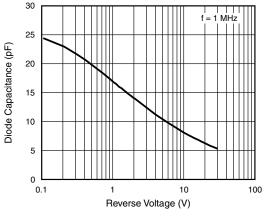


Fig. 5 - Diode Capacitance vs. Reverse Voltage

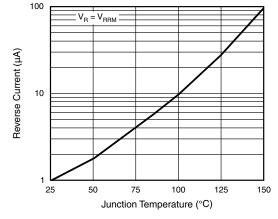


Fig. 3 - Reverse Current vs. Junction Temperature

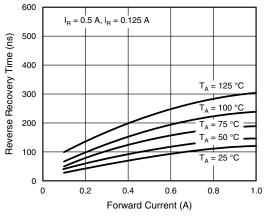


Fig. 6 - Reverse Recovery Time vs. Forward Current



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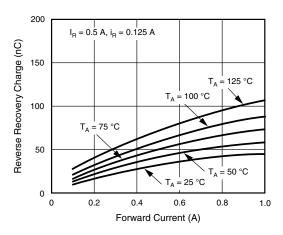


Fig. 7 - Reverse Recovery Charge vs. Forward Current

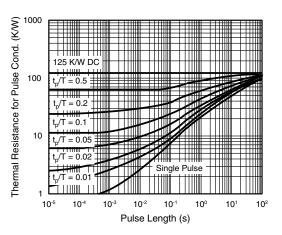
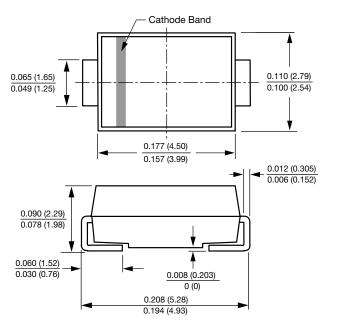


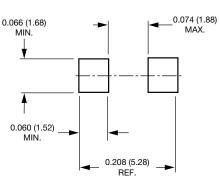
Fig. 8 - Thermal Response

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)



Mounting Pad Layout





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